



PCB Number: PMP8861  
PCB Rev: C

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Number: PMP8861	Rev: C	Designed for: 18V-72V Input, 12V/10A Quarter Brick	Mod. Date: 5/30/2016
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Engineer: B King	Contact: http://www.ti.com/support	© Texas Instruments 2016	



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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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